Preferred Device

Schottky Barrier Diodes

Designed primarily for UHF mixer applications but suitable also for use in detector and ultra-fast switching circuits. Supplied in an inexpensive plastic package for low-cost, high-volume consumer requirements. Also available in Surface Mount package.

Features

- Low Noise Figure 6.0 dB Typ @ 1.0 GHz
- Very Low Capacitance Less Than 1.0 pF
- High Forward Conductance -0.5 V (Typ) @ $I_F = 10 \text{ mA}$
- Pb-Free Packages are Available

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Reverse Voltage	V _R	7.0	V
Forward Power Dissipation $T_A = 25^{\circ}C$ MBD101 MMBD101LT1 Derate above 25°C MBD101 MMBD101LT1	P _F	280 225 2.2 1.8	mW mW/°C
Junction Temperature	TJ	+150	°C
Storage Temperature Range	T _{stg}	-55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Breakdown Voltage $(I_R = 10 \mu A)$	V _{(BR)R}	7.0	10	1	V
Diode Capacitance (V _R = 0, f = 1.0 MHz, Note 1, page 2)	C _D	-	0.88	1.0	pF
Forward Voltage (I _F = 10 mA)	V _F	ı	0.5	0.6	V
Reverse Leakage (V _R = 3.0 V)	I _R	_	0.02	0.25	μΑ

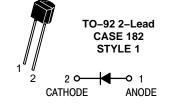


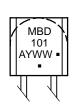
ON Semiconductor®

http://onsemi.com

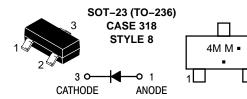
SILICON SCHOTTKY BARRIER DIODES

K DIODES MARKING





DIAGRAMS



(Pin 2 Not Connected)

A = Assembly Location

Y = Year

WW = Work Week

4M = Device Code (SOT-23)

M = Date Code*

= Pb–Free Package

(Note: Microdot may be in either location)
*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
MBD101	TO-92	5000 Units / Box
MBD101G	TO-92 (Pb-Free)	5000 Units / Box
MMBD101LT1	SOT-23	3000 / Tape & Reel
MMBD101LT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

TYPICAL CHARACTERISTICS

 $(T_A = 25^{\circ}C \text{ unless noted})$

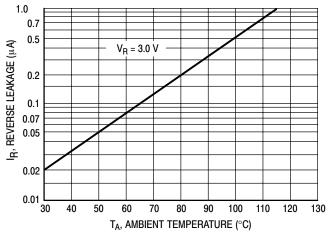


Figure 1. Reverse Leakage

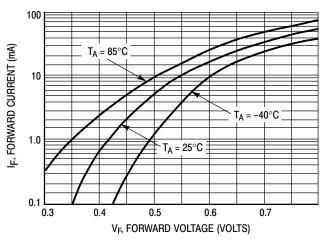


Figure 2. Forward Voltage

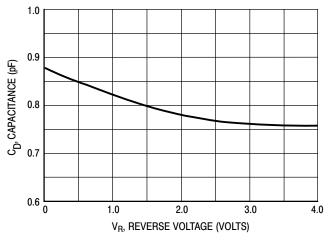


Figure 3. Capacitance

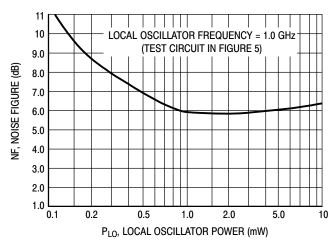


Figure 4. Noise Figure

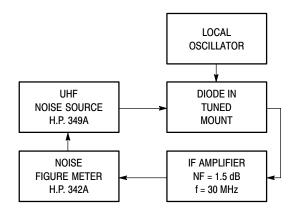


Figure 5. Noise Figure Test Circuit

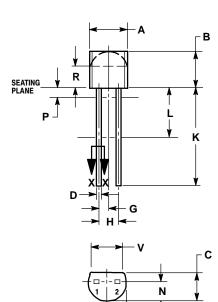
NOTES ON TESTING AND SPECIFICATIONS

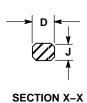
- Note 1 C_D is measured using a capacitance bridge (Boonton Electronics Model 75A or equivalent).
- Note 2 Noise figure measured with diode under test in tuned diode mount using UHF noise source and local oscillator (LO) frequency of 1.0 GHz. The LO power is adjusted for 1.0 mW. IF amplifier NF = 1.5 dB, f = 30 MHz, see Figure 5.
- Note 3 L_S is measured on a package having a short instead of a die, using an impedance bridge (Boonton Radio Model 250A RX Meter).

PACKAGE DIMENSIONS

TO-92 TWO LEAD

TO-226AC CASE 182-06 **ISSUE L**





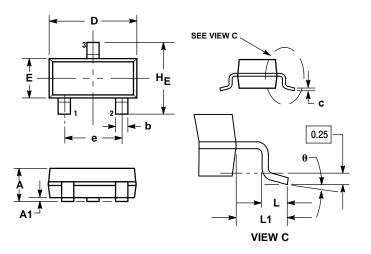
- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. CONTOUR OF PACKAGE BEYOND ZONE R IS UNCONTROLLED.
 4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.175	0.205	4.45	5.21	
В	0.170	0.210	4.32	5.33	
С	0.125	0.165	3.18	4.19	
D	0.016	0.021	0.407	0.533	
G	0.050 BSC		1.27 BSC		
Н	0.100 BSC		2.54 BSC		
J	0.014	0.016	0.36	0.41	
K	0.500		12.70		
L	0.250	-	6.35	-	
N	0.080	0.105	2.03	2.66	
P		0.050		1.27	
R	0.115		2.93		
v	0 135		3 43		

STYLE 1: PIN 1. ANODE 2. CATHODE

PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 **ISSUE AN**



NOTES:

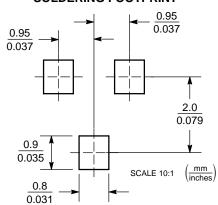
- DIMENSIONING AND TOLERANCING PER ANSI
 Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL
- 318-01 THRU -07 AND -09 OBSOLETE, NEW STANDARD 318-08.

		MILLIMETERS			INCHES			
	DIM	MIN	NOM	MAX	MIN	NOM	MAX	
	Α	0.89	1.00	1.11	0.035	0.040	0.044	
	A1	0.01	0.06	0.10	0.001	0.002	0.004	
	b	0.37	0.44	0.50	0.015	0.018	0.020	
	С	0.09	0.13	0.18	0.003	0.005	0.007	
	D	2.80	2.90	3.04	0.110	0.114	0.120	
I	Е	1.20	1.30	1.40	0.047	0.051	0.055	
	Ф	1.78	1.90	2.04	0.070	0.075	0.081	
Ī	٦	0.10	0.20	0.30	0.004	0.008	0.012	
[L1	0.35	0.54	0.69	0.014	0.021	0.029	
[ΗE	2.10	2.40	2.64	0.083	0.094	0.104	

STYLE 8:

- PIN 1.
- ANODE NO CONNECTION
 - CATHODE

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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